Ceramic Monoblock Duplex Filter

CTS.

WIRELESS COMPONENTS

Model KFF6567A Technical Data

Features:

- Small Size
- High Performance
- SMD

Description and Applications:

This monoblock Duplexer filter is primarily designed for Cellular Band (CDMA and AMPS) applications at 824-894 MHz.



Electrical Specifications

TX to Antenna Response	Frequency	Specifications @ 25° C
Insertion Loss	824 MHz to 849 MHz	2.5 dB max.
Return Loss @ TX		10.0 dB min.
Attenuation	779 MHz to 804 MHz	10.0 dB min.
Attenuation	869 MHz to 894 MHz	45.0 dB min.
Antenna to RX Response	Frequency	Specifications @ 25° C
Insertion Loss	- 869 MHz to 894 MHz	3.3 dB max.
Return Loss @ RX		8.0 dB min.
Attenuation	824 MHz to 849 MHz	52.0 dB min.
Attenuation	914 MHz to 939 MHz	20.0 dB min.
Attenuation	959 MHz to 984 MHz	45.0 dB min.
Power Rating		3W
Impedance		50Ω

NOTE: Supplier shall test each filter to the critical electrical specifications listed above or better. Any subsequent audits may deviate due to measurement repeatability among different test systems. Such deviations shall not exceed the following limits:

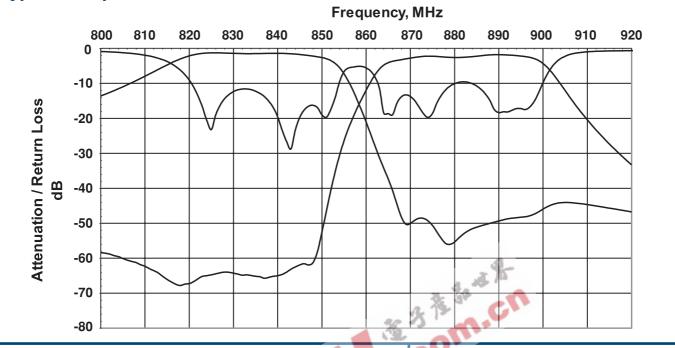
Specification	Typical Allowance
Insertion Loss	0.1dB
Return Loss	1.0dB
Stopbands	1.0dB

Rev. 1

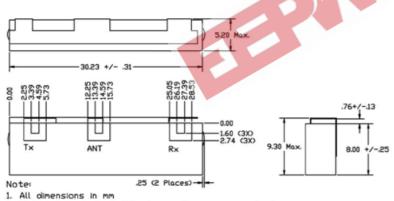
CTS WIRELESS COMPONENTS

MODEL KFF6567A

Typical Response Curve



Mechanical Dimensions



2. Tolerances are +/-.25 unless otherwise specified

Part Marking

Y = LAST DIGIT OF YEAR WW = SEQUENTIAL WEEK NUMBER



Contact Information:

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I/O Conductor Ground Conductor Dielectric Area (SX) (SX) (SX) (SX) 22.32 23.34 24.80 26.32 26.32 26.32 26.32 26.32 26.32 26.32 27.26 29.72 858 111 (8X) (3X) (5X) (5X) (3X) Ø 2.32 (2X) 1.35 2.99 4.8 6.08 Ø 11 //////

PC Board Layout

- Notes: 1. All dimensions in mm 2. Tolerances are +/-13 3. Ground plane under Tx, Rx and Antenna pads and the dielectric area that surrounds them should be at least .63 nm below top surface. There should also be no active traces under these areas. 4. Via ground holes (not shown in drawing) should be .254 nm in dianeter with a pitch of 127 nm. There should be a minimum of 2 via holes per ground pad.

Packaging

